

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	209712	circuit adj board	USPAT; EPO; JPO; DERWENT	2002/02/22 18:02
2	BRS	L2	948	1 and (plating adj layer)	USPAT; EPO; JPO; DERWENT	2002/02/22 19:06
3	BRS	L3	349	2 and nickel	USPAT; EPO; JPO; DERWENT	2002/02/22 18:03
4	BRS	L4	266	3 and thickness	USPAT; EPO; JPO; DERWENT	2002/02/22 18:09
5	BRS	L5	7	4 and (solder adj bump)	USPAT; EPO; JPO; DERWENT	2002/02/22 18:09
6	BRS	L6	73	1 and (nickel adj plating adj layer)	USPAT; EPO; JPO; DERWENT	2002/02/22 18:09
7	BRS	L7	46	6 and thickness	USPAT; EPO; JPO; DERWENT	2002/02/22 18:09
8	BRS	L8	3	7 and (solder adj bump)	USPAT; EPO; JPO; DERWENT	2002/02/22 19:06

	Type	L #	Hits	Search Text	DBs	Time Stamp
9	BRS	L9	17	("3781596" "5134461" "5175609" "5190601" "5635764" "5838069").PN.	USPAT; EPO; JPO; DERWENT	2002/02/22 18:10
10	BRS	L11	0	10 and 2	USPAT; EPO; JPO; DERWENT	2002/02/22 18:28
11	BRS	L10	19	1 and (suspension adj substrate)	USPAT; EPO; JPO; DERWENT	2002/02/22 18:28
12	BRS	L12	4	6 and (solder adj bump)	USPAT; EPO; JPO; DERWENT	2002/02/22 19:03
13	BRS	L13	3	12 and tin	USPAT; EPO; JPO; DERWENT	2002/02/22 19:03
14	BRS	L14	2	12 and (tin and silver and copper)	USPAT; EPO; JPO; DERWENT	2002/02/22 19:06
15	BRS	L15	377	361/803.ccls.	USPAT; EPO; JPO; DERWENT	2002/02/22 19:05
16	BRS	L16	246	15 and 1	USPAT; EPO; JPO; DERWENT	2002/02/22 19:05

	Type	L #	Hits	Search Text	DBs	Time Stamp
17	BRS	L17	0	16 and (plating adj layer)	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:06
18	BRS	L18	9	16 and (solder adj bump)	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:10
19	BRS	L19	1	18 and (tin and silver and copper)	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:07
20	BRS	L20	1	19 and nickel	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:07
21	BRS	L21	1	19 and (nickel same layer)	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:08
22	IS&R	L22	147	("361/762").CCLS.	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:09
23	BRS	L23	3	361/762.ccls. and (plating adj layer)	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:10
24	BRS	L25	0	24 and (solder adj bump)	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:10

	Type	L #	Hits	Search Text	DBs	Time Stamp
25	BRS	L24	2	23 and nickel	USPAT; EPO; JPO; DERWEN T	2002/02/22 19:10